

Micro Chip Fuse

Type: **ERBRD ERBRE**

ERBRG







Features

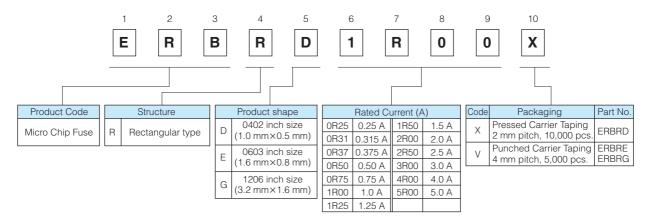
- Small size
- Fast-acting and withstanding in-rush current characteristics
- RoHS compliant

Approved Safety Standards

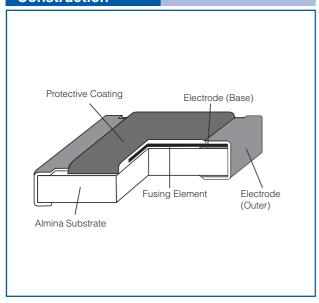
UL248-14 : File No.E194052

c-UL C22.2 No.248-14 : File No.E194052

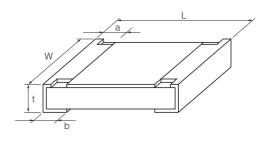
Explanation of Part Numbers



Construction



Dimensions in mm (not to scale)



Part No.		Mass (Moight)				
(inch size)	L	W	а	b	t	(Weight) (g/1000 pcs.)
ERBRD (0402)	1.00 ^{±0.10}	0.50+0.10	0.15 ^{±0.10}	0.25 ^{±0.10}	0.39 ^{±0.10}	0.7
ERBRE (0603)	1.60 ^{±0.15}	0.80+0.15	0.24 ^{±0.15}	0.30 ^{±0.15}	0.54 ^{±0.10}	2.2
ERBRG (1206)	3.20 ^{±0.20}	1.60 ^{±0.15}	0.30 ^{±0.20}	0.55 ^{±0.20}	0.65 ^{±0.10}	10



Ratings

• 0402 inch /1005 mm size : Type ERBRD

Part No.		ERBRD□R□□X									
raitino.	0R25	0R31	0R37	0R50	0R75	1R00	1R25	1R50	2R00	2R50	3R00
Rated Current (A)	0.25	0.315	0.375	0.5	0.75	1.0	1.25	1.5	2.0	2.5	3.0
Marking Code	V	Χ	Υ	F	G	Н	J	K	N	0	Р
Internal R (m Ω) at 25 °C max.	700	520	440	310	190	125	82	70	53	42	37
- · · · · · · · · · · · ·				Rated C	Current ×	100 % /	4 hours i	min.			
Fusing Current/Fusing Time (at 25 °C)				Rated C	Current ×	200 % /	5 second	ds max.			
(at 20°0)				Rated C	Current ×	300 % /	0.2 seco	nds max	ζ.		
Rated Voltage (Open Circuit Voltage)						32 VDC					
Interrupting Rating (at Rated Voltage)						35 A					
Category Temp. Range					-40 °	°C to +12	25 °C				

• 0603 inch / 1608 mm size : Type ERBRE

Part No.	ERBRE□R□□V									
ran No.	0R50	0R75	1R00	1R25	1R50	2R00	2R50	3R00	4R00	5R00
Rated Current (A)	0.5	0.75	1.0	1.25	1.5	2.0	2.5	3.0	4.0	5.0
Marking Code	F	G	Н	J	K	N	0	Р	S	Т
Internal R (m Ω) at 25 °C max.	330	190	125	94	72	51	40	33	22	19
- · · · · · · · · · · · · · · ·			R	ated Curr	ent ×100	% / 4 hou	ırs min.			
Fusing Current/Fusing Time (at 25 °C)			R	ated Curr	ent ×200	% / 5 sec	conds ma	X.		
(41 20 0)			R	ated Curr	ent ×300	% / 0.2 s	econds m	nax.		
Rated Voltage (Open Circuit Voltage)					32 \	/DC				
Interrupting Rating (at Rated Voltage)					50) A				
Category Temp. Range					−40 °C to	+125 °C				

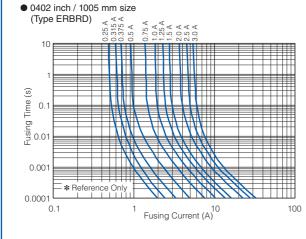
• 1206 inch / 3216 mm size : Type ERBRG

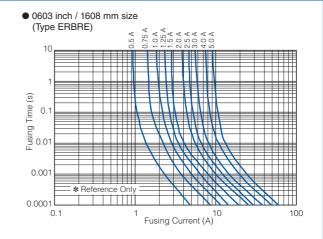
Part No.		ERBRG□R□□V									
Part No.	0R50	0R75	1R00	1R25	1R50	2R00	2R50	3R00	4R00		
Rated Current (A)	0.5	0.75	1.0	1.25	1.5	2.0	2.5	3.0	4.0		
Marking Code	F	G	Н	J	K	N	0	Р	S		
Internal R (m Ω) at 25 °C max.	560	340	210	175	115	85	65	45	35		
F : 0 : F : T			Rate	d Current :	×100 % / 4	hours mir	1.				
Fusing Current/Fusing Time (at 25 °C)		Rated Current ×200 % / 5 seconds max.									
(at 20 0)			Rate	d Current :	×300 % / C	.2 second	s max.				
Rated Voltage			63 \	/DC				32 VDC			
(Open Circuit Voltage)								02 100			
Interrupting Rating					50 A						
(at Rated Voltage)											
Category Temp. Range				-40	°C to +12	5°C					

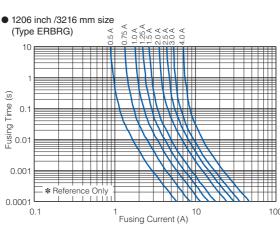
 $[\]clubsuit$ The thin type is available about 1005 (0402 inch) size. Please contact us for details. \bigstar Please contact us when another rated current is needed.



Fusing Characteristics (25 °C typical)







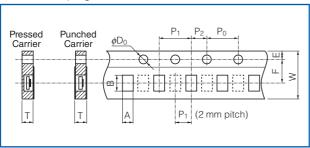
Packaging Methods

Standard Quantity

Part No.	inch size	Kind of Taping	Pitch (P ₁)	Quantity
ERBRD	0402	Pressed Carrier Taping	2 mm	10,000 pcs./ reel
ERBRE	0603	Dunched Carrier Taning	4 mm	5 000 pag / rool
ERBRG	1206	Punched Carrier Taping	4 mm	5,000 pcs./ reel

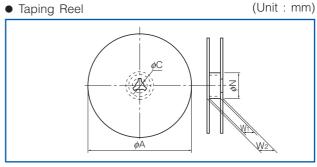
(Unit: mm)





Part No.	А	В	W	F	Е
ERBRD	0.68 ^{±0.10}	1.20 ^{±0.10}			
ERBRE	1.10 ^{±0.10}	1.90 ^{±0.10}	8.00 ^{±0.20}	3.50 ^{±0.05}	1.75 ^{±0.10}
ERBRG	2.00 ^{±0.15}	3.60 ^{±0.20}			
D					
Part No.	P ₁	P ₂	P ₀	ø D₀	Т
ERBRD	P ₁ 2.00 ^{±0.10}			,	T 0.67 ^{±0.07}
	1 1	P ₂ 2.00 ^{±0.05}	P ₀ 4.00 ^{±0.10}	φ _{D0} 1.50 ^{+0.10}	T 0.67 ^{±0.07} 0.78 ^{±0.07} 0.84 ^{±0.07}

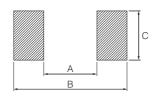
• Taping Reel



Part No.	φA	φN	φC	W ₁	W2
ERBRD ERBRE ERBRG	180.0-1.5	60 +1.0	13.0 ^{±0.2}	9.0 +1.0	11.4 ^{±1.0}



Recommended Soldering Conditions

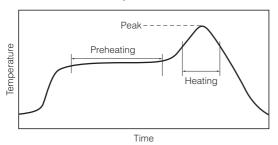


Part No.	Dimensions (mm)					
(inch size)	А	В	С			
ERBRD(0402)	0.5 to 0.6	1.4 to 1.6	0.4 to 0.6			
ERBRE(0603)	0.7 to 0.9	2.0 to 2.2	0.8 to 1.0			
ERBRG(1206)	2.0 to 2.4	4.4 to 5.0	1.2 to 1.8			

Recommended Soldering Conditions

Recommendations and precautions are described below.

- Recommended soldering conditions for reflow
- Reflow soldering shall be performed a maximum of two times
- · Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



For soldering (Example : Sn/Pb)

	Temperature	Time
Preheating	140 °C to 160 °C	60 s to 120 s
Main heating	Above 200 °C	30 s to 40 s
Peak	235 ± 5 °C	max. 10 s

For lead-free soldering (Example : Sn/Ag/Cu)

	Temperature	Time
Preheating	150 °C to 180 °C	60 s to 120 s
Main heating	Above 230 °C	30 s to 40 s
Peak	max. 260 °C	max. 10 s

Recommended soldering conditions for flow

	For sol	dering	For lead-free soldering		
	Temperature Time		Temperature	Time	
Preheating	140 °C to 180 °C	60 s to 120 s	150 °C to 180 °C	60 s to 120 s	
Soldering	245 ± 5 °C	20 s to 30 s	max. 260 °C	max. 10 s	

<Repair with hand soldering>

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less.
 Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

∆Safety Precautions

The following are precautions for individual products. Please also refer to the common precautions for fuses in this catalog.

- 1. Set the rated current so that the current passing through the Micro Chip Fuses (hereafter called the fuses) under normal conditions is within 70% of the rated current.
- 2. Do not continuously pass a current exceeding the rated current through the fuses.
- 3. If a pulse exceeding the rated current is applied, such as a rush current or surge current at power-on, take care not to cause unwanted fusing. Calculate the I²t value of the pulse and check the tolerance to the number of pulses according to the I²t-t characteristic curve before deciding to use the fuses. Before checking the tolerance, consult our sales staff in advance.
- 4. The fuses are designed to be blown out by a current that is double or greater than the rated current. Ensure that the abnormal current generated when a circuit abnormality occurs in your product is at least double or greater than the rated current of the fuses. In addition, ensure that the abnormal current of your product does not exceed the maximum interrupting current of the fuses.
- 5. The fuses are designed to be used on the secondary side of a power supply. Do not use them on the primary side.
- 6. Ensure that the voltage applied to the fuses are within their rated voltage.
- 7. The fusing characteristics of the fuses are affected by the ambient temperature. Before use, mount the fuses on your products and carefully check and evaluate their category temperature range.